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IRL640A

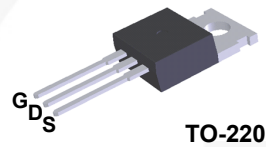
N-Channel Logic Level A-FET 200 V, 18 A, 180 mΩ

Description

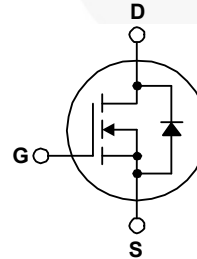
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supply and motor control.

Features

- 18 A, 200 V, $R_{DS(on)} = 180 \text{ m}\Omega @ V_{GS} = 5 \text{ V}$
- Low Gate Charge (Typ. 40 nC)
- Low Crss (Typ. 95 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- Logic-Level Gate Drive



TO-220



Absolute Maximum Ratings

| Symbol | Characteristic | Value | Units |
|----------------|---|--------------|------------------|
| V_{DSS} | Drain-to-Source Voltage | 200 | V |
| I_D | Continuous Drain Current ($T_C=25^\circ\text{C}$) | 18 | A |
| | Continuous Drain Current ($T_C=100^\circ\text{C}$) | 11.4 | |
| I_{DM} | Drain Current-Pulsed (1) | 63 | A |
| V_{GS} | Gate-to-Source Voltage | ± 20 | V |
| E_{AS} | Single Pulsed Avalanche Energy (2) | 64 | mJ |
| I_{AR} | Avalanche Current (1) | 18 | A |
| E_{AR} | Repetitive Avalanche Energy (1) | 11 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (3) | 5 | V/ns |
| P_D | Total Power Dissipation ($T_C=25^\circ\text{C}$) | 110 | W |
| | Linear Derating Factor | 0.88 | |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | - 55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temp. for Soldering Purposes, 1/8. from case for 5-seconds | 300 | |

Thermal Resistance

| Symbol | Characteristic | Typ. | Max. | Units |
|-----------------|---------------------|------|------|---------------------------|
| $R_{\theta JC}$ | Junction-to-Case | -- | 1.14 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta CS}$ | Case-to-Sink | 0.5 | -- | |
| $R_{\theta JA}$ | Junction-to-Ambient | -- | 62.5 | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|----------|
| IRL640A | IRL640A | TO-220 | Tube | N/A | N/A | 50 units |

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Characteristic | Min. | Typ. | Max. | Units | Test Condition |
|------------------------|---|------|------|------|---------------------|---|
| BV_{DSS} | Drain-Source Breakdown Voltage | 200 | -- | -- | V | $V_{GS}=0V, I_D=250\mu A$ |
| $\Delta BV/\Delta T_J$ | Breakdown Voltage Temp. Coeff. | -- | 0.17 | -- | V/ $^\circ\text{C}$ | $I_D=250\mu A$ See Fig 7 |
| $V_{GS(th)}$ | Gate Threshold Voltage | 1.0 | -- | 2.0 | V | $V_{DS}=5V, I_D=250\mu A$ |
| I_{GSS} | Gate-Source Leakage, Forward | -- | -- | 100 | nA | $V_{GS}=20V$ |
| | Gate-Source Leakage, Reverse | -- | -- | -100 | | $V_{GS}=-20V$ |
| I_{DSS} | Drain-to-Source Leakage Current | -- | -- | 10 | μA | $V_{DS}=200V$ |
| | | -- | -- | 100 | | $V_{DS}=160V, T_C=125^\circ\text{C}$ |
| $R_{DS(on)}$ | Static Drain-Source On-State Resistance | -- | -- | 0.18 | Ω | $V_{GS}=5V, I_D=9A$ (4) |
| g_{fs} | Forward Transconductance | -- | 13.3 | -- | \bar{S} | $V_{DS}=40V, I_D=9A$ (4) |
| C_{iss} | Input Capacitance | -- | 1310 | 1705 | pF | $V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$ See Fig 5 |
| C_{oss} | Output Capacitance | -- | 200 | 250 | | |
| C_{rss} | Reverse Transfer Capacitance | -- | 95 | 120 | | |
| $t_{d(on)}$ | Turn-On Delay Time | -- | 11 | 30 | | |
| t_r | Rise Time | -- | 8 | 25 | ns | $V_{DD}=100V, I_D=18A,$ $R_G=4.6\Omega$ See Fig 13 (4) (5) |
| $t_{d(off)}$ | Turn-Off Delay Time | -- | 46 | 100 | | |
| t_f | Fall Time | -- | 15 | 40 | | |
| Q_g | Total Gate Charge | -- | 40 | 56 | nC | $V_{DS}=160V, V_{GS}=5V,$ $I_D=18A$ See Fig 6 & Fig 12 (4) (5) |
| Q_{gs} | Gate-Source Charge | -- | 6.8 | -- | | |
| Q_{gd} | Gate-Drain (. Miller.) Charge | -- | 18.6 | -- | | |

Source-Drain Diode Ratings and Characteristics

| Symbol | Characteristic | Min. | Typ. | Max. | Units | Test Condition |
|----------|---------------------------|------|------|------|---------------|--|
| I_S | Continuous Source Current | -- | -- | 18 | A | Integral reverse pn-diode in the MOSFET |
| I_{SM} | Pulsed-Source Current (1) | -- | -- | 63 | | |
| V_{SD} | Diode Forward Voltage (4) | -- | -- | 1.5 | V | $T_J=25^\circ\text{C}, I_S=18A, V_{GS}=0V$ |
| t_{rr} | Reverse Recovery Time | -- | 224 | -- | ns | $T_J=25^\circ\text{C}, I_F=18A$ |
| Q_{rr} | Reverse Recovery Charge | -- | 1.55 | -- | μC | $di_F/dt=100A/\mu\text{s}$ (4) |

Notes;

- (1) Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- (2) $L=0.3\text{mH}, I_{AS}=18A, V_{DD}=50V, R_G=27\Omega,$ Starting $T_J=25^\circ\text{C}$
- (3) $I_{SD} \leq 18A, di/dt \leq 260A/\mu\text{s}, V_{DD} \leq BV_{DSS},$ Starting $T_J=25^\circ\text{C}$
- (4) Pulse Test: Pulse Width = $250\mu\text{s},$ Duty Cycle $\leq 2\%$
- (5) Essentially Independent of Operating Temperature

Typical Characteristics

Fig 1. Output Characteristics

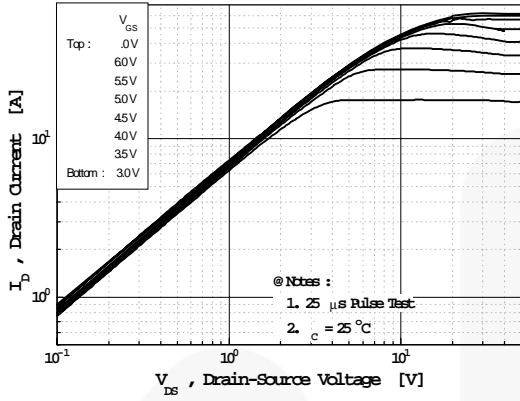


Fig 2. Transfer Characteristics

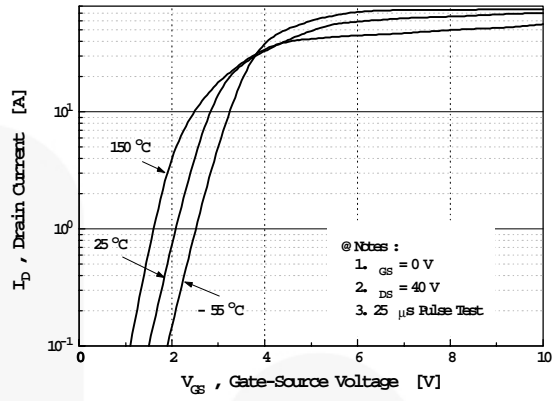


Fig 3. On-Resistance vs. Drain Current

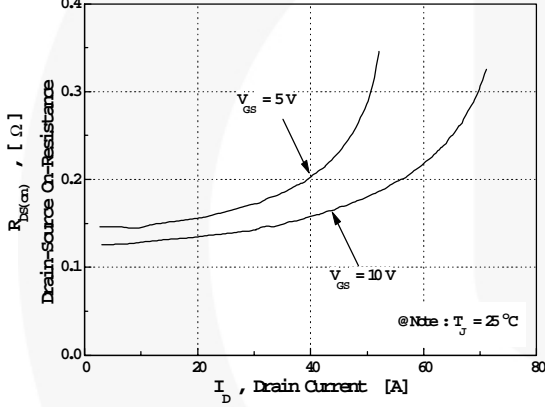


Fig 4. Source-Drain Diode Forward Voltage

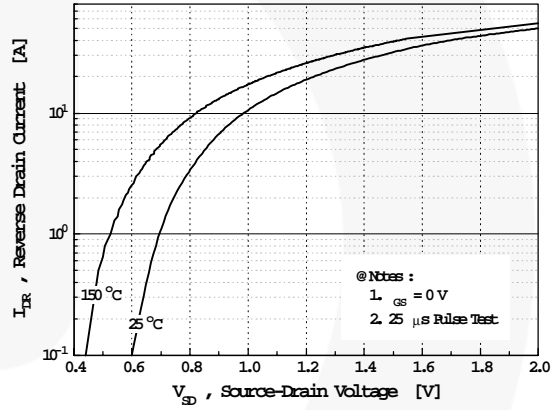


Fig 5. Capacitance vs. Drain-Source Voltage

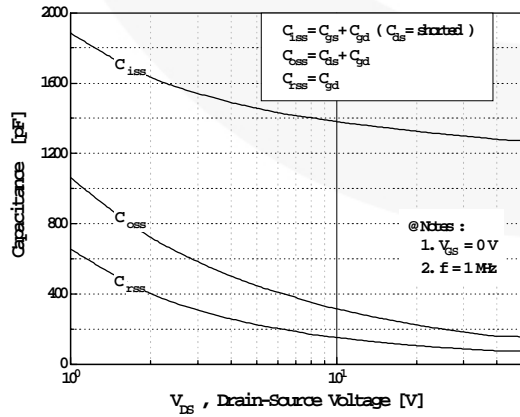
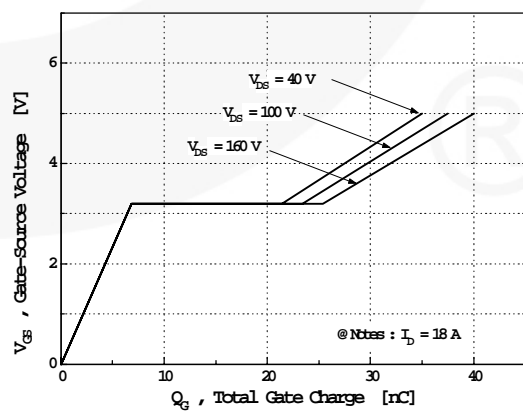


Fig 6. Gate Charge vs. Gate-Source Voltage



Typical Characteristics (continued)

Fig 7. Breakdown Voltage vs. Temperature

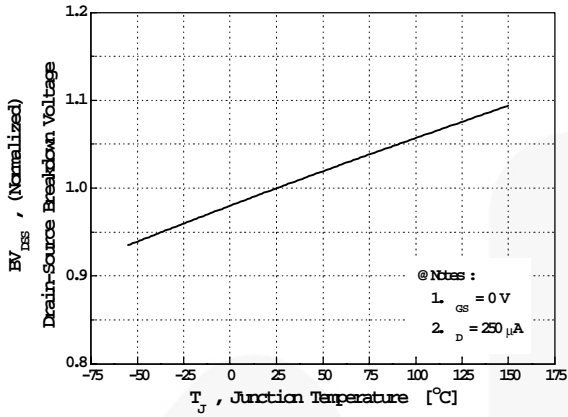


Fig 8. On-Resistance vs. Temperature

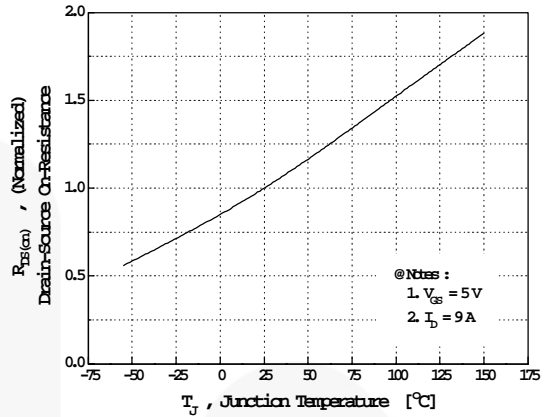


Fig 9. Max. Safe Operating Area

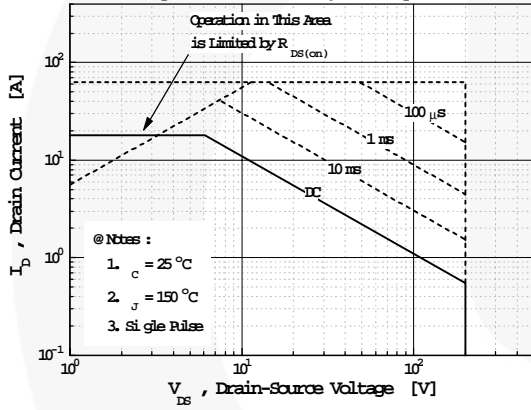


Fig 10. Max. Drain Current vs. Case Temperature

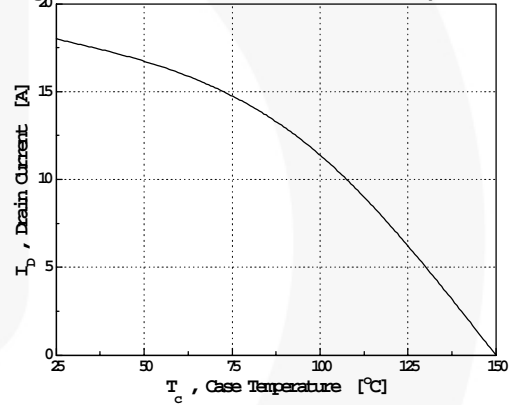
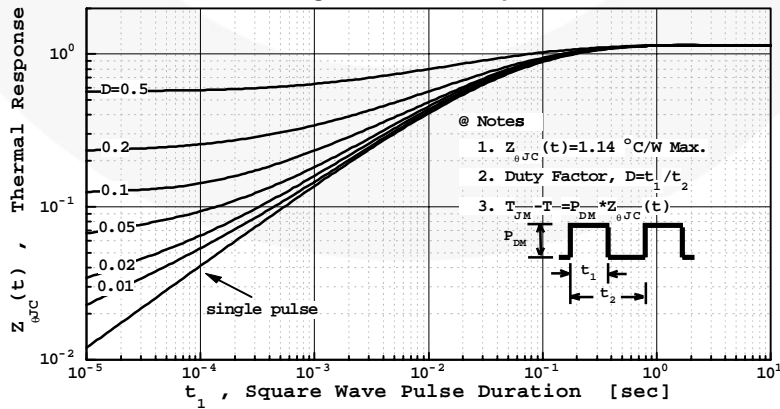


Fig 11. Thermal Response



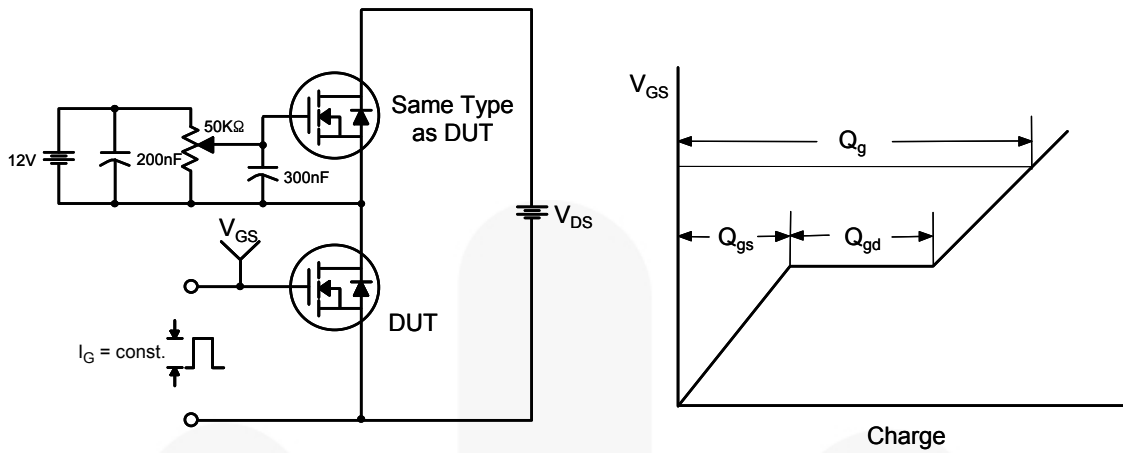


Figure 12. Gate Charge Test Circuit & Waveform



Figure 13. Resistive Switching Test Circuit & Waveforms

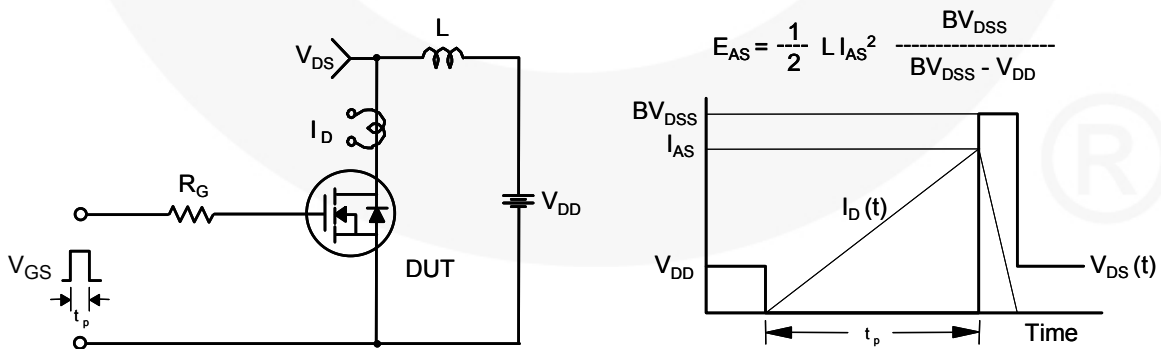
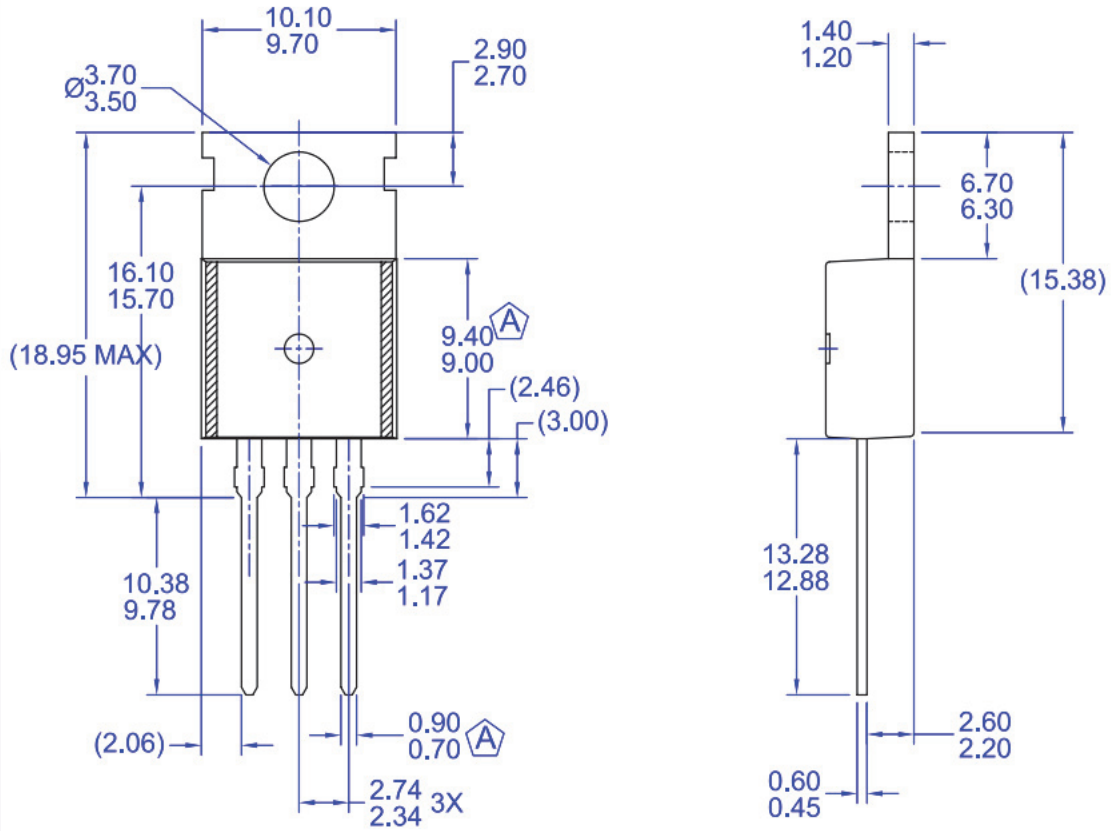


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions



NOTES:

- A) CONFORMS TO JEDEC TO-220 VARIATION AB EXCEPT WHERE NOTED
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DRAWING FILE/REVISION: MKT-TO220Y03REV1

Figure 16. TO220, Molded, 3-Lead, Jedec Variation AB

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